RoHS

COMPLIANT

HALOGEN FREE

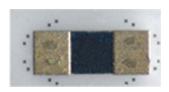
**GREEN** 

(5-2008)





# **Thin Film Microwave Resistor**



The MIB resistor chips on alumina are designed with low shunt capacitance. Resistor geometrics are compatible with strip lines, making them ideally suited for microwave circuits.

These chips are manufactured using Vishay Electro-Films (EFI) sophisticated Thin Film equipment and manufacturing technology. The MIBs are 100 % electrically tested and visually inspected to MIL-STD-883.

#### **FEATURES**

- Wire bondable
- · High frequency
- Small single chip size: 0.010" x 0.020"
- Case: 0201
- Microwave resistance range: 20  $\Omega$  to 100  $\Omega$
- Overall resistance range: 20  $\Omega$  to 1 k $\Omega$
- Alumina substrate
- Low stray capacitance: < 0.2 pF</li>
- Resistor material: Tantalum nitride, self passivating
- Moisture resistant
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### **APPLICATIONS**

Vishay EFI MIB chip resistors provide excellent high-frequency response and are ideally suited for prototyping.

Typical application areas are:

- Amplifiers
- Oscillators
- Attenuators
- Couplers
- Filters

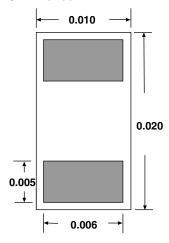
TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES		
PARAMETER	VALUE	UNIT
Resistance Range	20 to 100	Ω
Tolerance	± 5, ± 10, ± 20 standard	%
TCR	± 100	ppm/°C

STANDARD ELECTRICAL SPECIFICATIONS		
PARAMETER	VALUE	UNIT
Noise, MIL-STD-202, Method 308	-20 typ.	dB
Moisture Resistance, MIL-STD-202, Method 106	± 0.5 max. Δ <i>R/R</i>	%
Stability, 1000 h, + 125 °C, 12 mW	± 0.5 max. Δ <i>R/R</i>	%
Operating Temperature Range	-55 to +125	°C
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	± 0.25 max. ∆R/R	%
High Temperature Exposure, + 150 °C, 1000 h	± 0.5 max. Δ <i>R/R</i>	%
Dielectric Voltage Breakdown	400	V
Insulation Resistance	10 <sup>12</sup> min.	Ω
Operating Voltage	100 max.	V
DC Power Rating at + 70 °C (Derated to Zero at 150 °C)	0.025 max.	W
5 x Rated Power Short-Time Overload, + 25 °C, 5 s	± 0.25 max. Δ <i>R/R</i>	%





## **DIMENSIONS** in inches

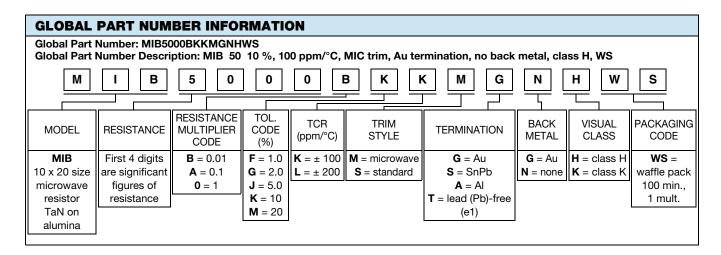


### **SCHEMATIC**



MECHANICAL SPECIFICATIONS		
PARAMETER	VALUE	
Chip Size	0.010" x 0.020" ± 0.002" (0.25 mm x 0.5 mm ± 0.08 mm)	
Chip Thickness	0.010" ± 0.002" (0.25 mm ± 0.05 mm)	
Chip Substrate Material	99.6 % alumina, 2 µ" to 4 µ" finish	
Resistor Material	Tantalum nitride, self passivating	
Bonding Pad Size	0.005" x 0.006" (0.127 mm x 0.152 mm)	
Number of Pads	2	
Pad Material	25 kÅ minimum gold standard	
Backing	None	

Options: Terminations: aluminum, gold back for solder die attach, contact applications engineer





# **Legal Disclaimer Notice**

Vishay

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